DATA SHEET

SILICON POWER TRANSISTOR 2SA1649, 2SA1649-Z

PNP SILICON EPITAXIAL POWER TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SA1649 is a mold power transistor developed for highspeed switching and features a very low collector-to-emitter saturation voltage.

This transistor is ideal for use in switching regulators, DC/DC converters, motor drivers, solenoid drivers, and other low-voltage power supply devices, as well as for high-current switching.

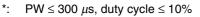
FEATURES

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- · Available for high-current control in small dimension
- Z type is a lead processed product and is deal for mounting a hybrid IC.
- Mold package that does not require an insulating board or insulation bushing
- Low collector saturation voltage: V_{CE(sat)} = -0.3 V MAX. (@Ic = -3 A)
- Fast switching speed:
 - tf = 0.3 μ s MAX. (@Ic = -3 A)
- High DC current amplifiers and excellent linearity

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-40	V
Collector to emitter voltage	Vceo	-30	V
Emitter to base voltage	Vebo	-7.0	V
Collector current (DC)	IC(DC)	-10	А
Collector current (pulse)	C(pulse)*	-20	А
Base current (DC)	B(DC)	-3.5	А
Total power dissipation	P⊤ (Tc = 25 °C)	15	W
Total power dissipation	P⊤ (Ta = 25 °C)	1.0**, 2.0***	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C



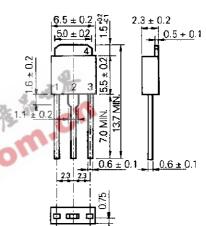
**: Printing board mounted

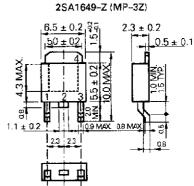
***: 7.5 mm² \times 0.7 mm ceramic board mounted

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PACKAGE DRAWING (UNIT: mm)

2SA1649 (MP-3)





Electrode Connection

- 1. Base 2. Collector
- 3. Emitter
- 4. Fin (collector)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	$I_{C} = -4.0 \text{ A}, I_{B} = -0.4 \text{ A}, L = 1 \text{ mH}$	-30			V
Collector to emitter voltage	VCEX(SUS)	Ic = -4.0 A, I _{B2} = -I _{B1} = -0.4 A, V _{BE(OFF)} = 1.5 V, L = 180 μ H, clamped	-40			V
Collector cutoff current	Ісво	$V_{CE} = -30 V, I_E = 0$			-10	μA
Collector cutoff current	ICER	$V_{CE} = -30 \text{ V}, \text{ R}_{BE} = 50 \Omega, \text{ Ta} = 125^{\circ}\text{C}$			-1.0	mA
Collector cutoff current	ICEX1	$V_{\text{CE}} = -30 \text{ V}, \text{ V}_{\text{BE(OFF)}} = 1.5 \text{ V}$			-10	μA
Collector cutoff current	ICEX2	$\label{eq:Vce} \begin{split} V_{\text{CE}} &= -30 \text{ V}, \text{ V}_{\text{BE(OFF)}} = 1.5 \text{ V}, \\ Ta &= 125^{\circ}\text{C} \end{split}$			-1.0	mA
Emitter cutoff current	Іево	$V_{EB} = -5.0 \text{ V}, \text{ Ic} = 0$			-10	μA
DC current gain	hfe1*	Vce = -2.0 V, Ic = -0.5 A	100			-
DC current gain	hFE2*	Vce = -2.0 V, Ic = -2.0 A	100	200	400	-
DC current gain	hfe3*	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -4.0 \text{ A}$	60			-
Collector saturation voltage	V _{CE(sat)1} *	Ic = −3.0 A, I _B = −0.2 A			-0.3	V
Collector saturation voltage	VCE(sat)2*	Ic = −4.0 A, I _B = −0.3 A		-	-0.5	V
Base saturation voltage	V _{BE(sat)1} *	Ic = -3.0 A, Iв = -0.2 A	1 15 M		-1.2	V
Base saturation voltage	VBE(sat)2*	Ic = -4.0 A, IB = -0.3 A	ar C		-1.5	V
Collector capacitance	Cob	Vсв = -10 V, IE = 0, f = 1.0 MHz	0 .	250		pF
Gain bandwidth product	f⊤	Vce = -10 V, Ic = -0.5 A		120		MHz
Turn-on time	ton	$Ic = -4.0 A, R_L = 5 \Omega,$			0.3	μs
Storage time	tstg	$I_{B1} = -I_{B2} = -0.15 \text{ A}, \text{ Vcc} \cong -20 \text{ V}$ Refer to the test circuit.			1.5	μs
Fall time	tr				0.3	μs

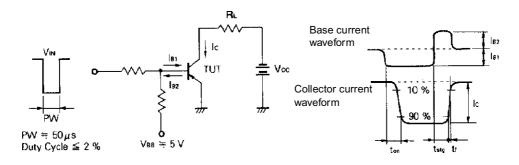
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

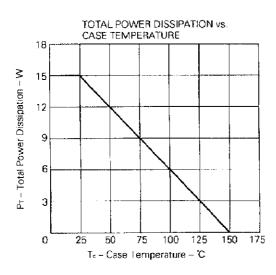
* Pulse test PW \leq 350 μ s, duty cycle \leq 2%/pulsed

hfe CLASSIFICATION

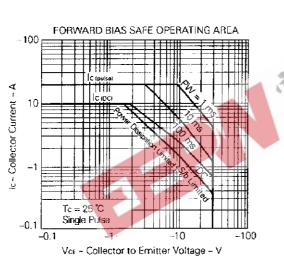
Marking	М	L	к
hfe2	100 to 200	150 to 300	200 to 400

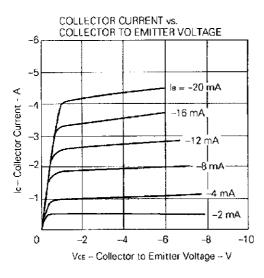
SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT

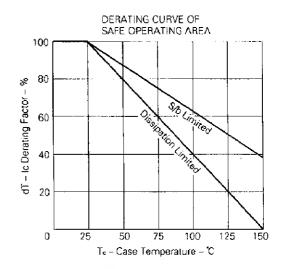


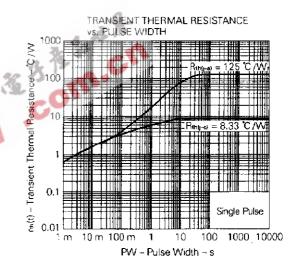


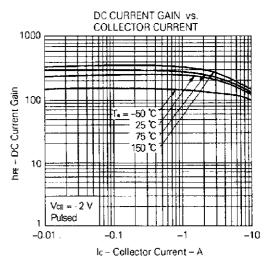




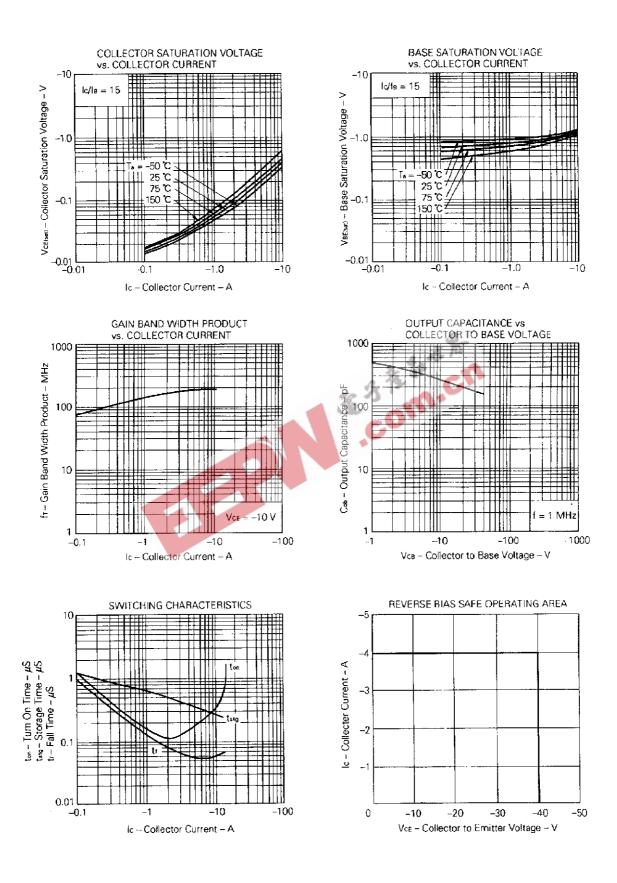












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